Special Issue

Frontiers in Ultra-Precision Machining, Volume II

Message from the Guest Editors

Ultra-precision machining is a multi-disciplinary research area that is an important branch of manufacturing technology. It targets achieving ultra-precision form or surface roughness accuracy, forming the backbone and support of today's innovative technology industries in aerospace, semiconductors, optics, telecommunications, energy, etc. The increasing demand for components with ultra-precision accuracy has stimulated the development of ultra-precision machining technology in recent decades. Accordingly, this Special Issue seeks reviews and regular research papers on the frontiers of ultra-precision machining and will serve as a platform for the communication of the latest developments and innovations in ultra-precision machining technologies.

Guest Editors

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Deadline for manuscript submissions

closed (31 March 2023)



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